1	6. Pursuant to 37 C.F.R. § 1.97(d), this information disclosure statement is being filed after the mailing date of either:		
2	a a final action under 37 C.F.R. § 1.113; or		
3	b a notice of allowance under 37 C.F.R. § 1.311,		
4			
5	but before payment of the issue fee. The statement is accompanied by a certification as specified in 37 C.F.R. § 1.97(e), a petition requesting		
6	consideration of the information disclosure statement, and the petition fee set forth in 37 C.F.R. § 1.17(i)(1). Check No. in the amount of		
7	\$ is enclosed.		
8	X 7. Please charge any additional fees or credit any overpayment to Deposit Account No. 01-1940. A copy of this sheet is enclosed.		
9	Respectfully submitted,		
11			
12	Ron anderson		
13	Ronald M. Anderson Registration No. 28,829		
14	I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed		
15	envelope as first class mail with postage thereon fully prepaid addressed to: Director of the Patent and Trademark Office, Arlington, VA 22202, on December 4,4002.		
16	Date: December 4, 2002		
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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT LISTING SHEET

Information Cited By Applicant(s) That May Be Material To The Prosecution Of The Subject Application

Golbig et al.

Attorney Docket No. CELL0018

Serial No.:

09/991,377

Group Art Unit: 1743

Filed:

November 15, 2001

Examiner:

Title:

DEC 1 2 2002 ENHANCING FLUID FLOW IN A STACKED PLATE MICROREACTOR

U.S. PATENT DOCUMENTS

*Examiner **Initial**

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Document No.

Date

<u>Name</u>

Class

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US₁

US2002/0080563

06/27/2001

Pence et al.

361

676

FOREIGN PATENT DOCUMENTS

NONE CITED

OTHER INFORMATION

NONE CITED

Examiner's Signature	Date
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RMA:MCK:ssa 12/4/02

^{*}Examiner: Initial if reference considered, whether or not citation is in conformance with M.P.E.P. § 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.